

LMN3660EX5F 30V N-Channel Enhancement Mode MOSFET

Features

- Low Gate Charge
- ESD Protected
- SOT-323 package design

Product Description

LMN3660E, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent R_{DS(ON)}, low gate charge.

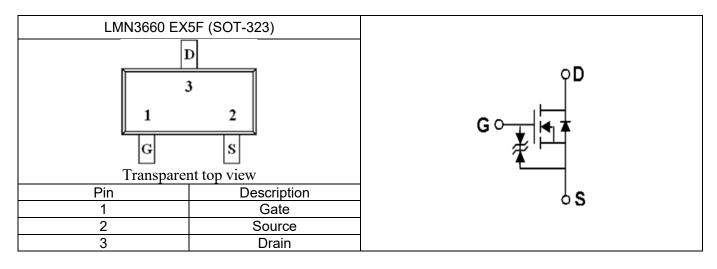
These devices are particularly suited for low

Pin Configuration

voltage power management, such as smart phone and notebook computer, and low in-line power loss are needed in commercial industrial surface mount applications.

Applications

- Power Management in Note book
- Portable Equipment
- Load Switch





Ordering Information

Ordering Information						
Part Number P/N		PKG code	Pb Free code	Package	Quantity	
LMN3660EX5F	LMN3660E	X5	F	SOT-323	3000 PCS	

Marking Information

Marking Information					
Part Marking	Part Number	LFC code			
0XWMM	0	XWMM			

Absolute Maximum Ratings

(T_C=25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Continuous Drain Current T _A =25°C ¹	0.56	A
I _{DM}	Pulsed Drain Current ²	2.3	A
P _D	Power Dissipation	0.34	W
TJ	Operating Junction Temperature	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C
R _{θJA}	Thermal Resistance-Junction to Ambient ¹	370	°C/W

Notes:

1. Surface mounted on a 1 inch2 FR-4 board with 2oz copper.

2. Pulse width limited by maximum junction temperature, Pulse Width≤300µs, Duty Cycle≤1%.



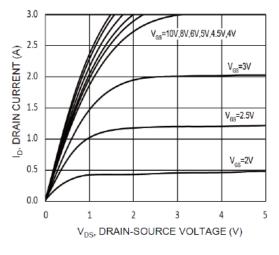
Electrical Characteristics

(T_C=25°C Unless otherwise noted)

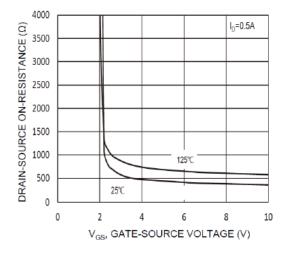
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Static							
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30			V	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250Ua	0.5		1.5		
I _{GSS}	Gate Leakage Current	$V_{DS}=0V$, $V_{GS}=\pm 12V$			10	uA	
IDSS	Zero Gate Voltage Drain Current	V_{DS} =24V, V_{GS} =0V			100	nA	
	Drain-Source On-Resistance	V _{GS} =10V, I _D =0.5A		345	600		
R _{DS(on)}		V _{GS} =4.5V, I _D =0.4A		425	650	mΩ	
		V _{GS} =2.5V, I _D =0.3A		650	1200		
g fs	Forward Transconductance	V _{DS} =10V, I _D =0.5A		1.2		S	
V_{SD}	Diode Forward Voltage	I _S =0.5A, V _{GS} =0V			1.35	V	
		Dynamic					
Q_g	Total Gate Charge	(1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -		1.5			
Q_gs	Gate-Source Charge	V _{DS} =15V, V _{GS} =10V, I _D =0.5A		0.2		nC	
Q_{gd}	Gate-Drain Charge	ID-0.5A		0.2			
Ciss	Input Capacitance			39			
Coss	Output Capacitance	V_{DS} =15V, V_{GS} =0V,		9		pF	
C _{rss}	Reverse Transfer Capacitance	f=1MHz		6			
t _{d(on)}	Turn On Time	V _{DD} =15V, I _D =0.5A,		5.3		ns	
tr	- Turn-On Time			16			
t _{d(off)}	Turn Off Time	V _{GS} =10V, R _G =2.5Ω		20			
t _f	Turn-Off Time			18			



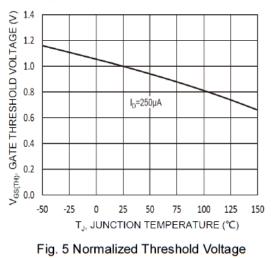
Typical Performance Characteristics











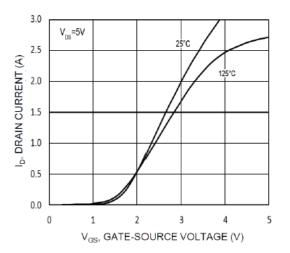
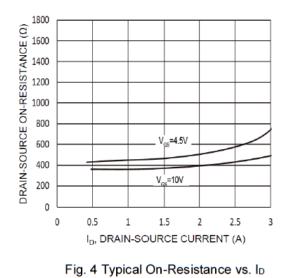
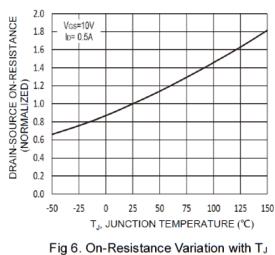


Fig. 2 Typical Transfer Characteristics

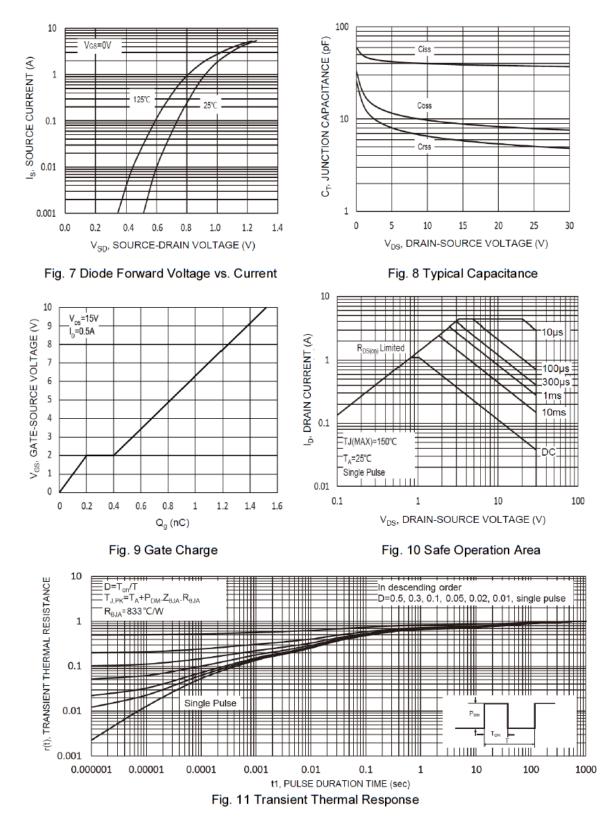




LMN3660EX5F



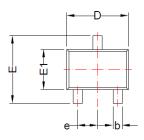
Typical Performance Characteristics(continue)



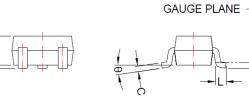


-0.2

SOT-323



A7 A2



	Dimensions				
Cumhal	Millimeters		Inches		
Symbol	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.000	0.004	
A2	0.80	1.00	0.031	0.039	
b	0.20	0.40	0.008	0.016	
С	0.08	0.26	0.003	0.010	
D	1.80	2.20	0.071	0.087	
E	1.80	2.40	0.071	0.094	
E1	1.15	1.35	0.045	0.053	
е	0.65 BSC		0.026 BSC		
L	0.26	0.45	0.010	0.018	
θ	0°	8°	0°	8°	



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